

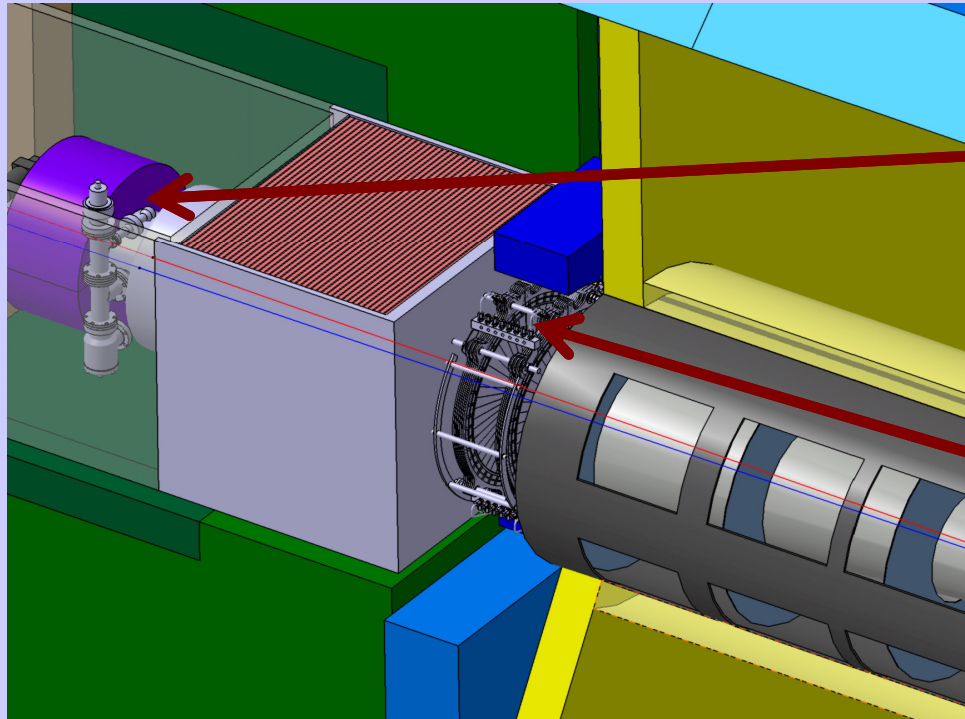
W. Lohmann, DESY,
on behalf of FCAL

- Simulation studies
- Sensors
- FE ASICs
- System Tests
- short- and midterm plans

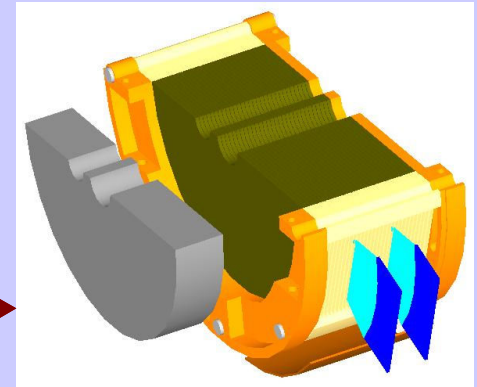


Labs involved: Argonne, Vinca Inst, Belgrade, Bukharest,
CERN, Univ. of Colorado, Cracow UST,
Cracow INP, IKP Dresden, JINR, Royal
Holloway, NCPHEP, UC Santa Cruz,
Stanford University, SLAC
Tuhoku Univ., Tel Aviv , Univ., DESY (Z.)

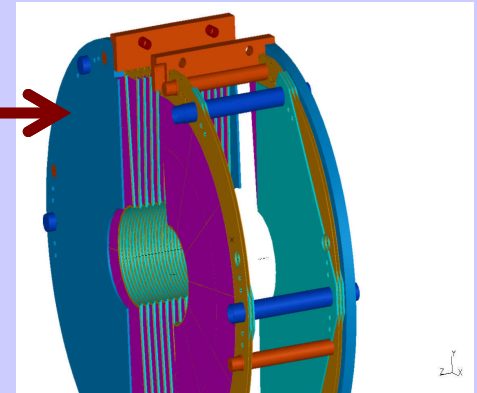
Very forward detectors- challenges



BeamCal
+ Pair
Monitor

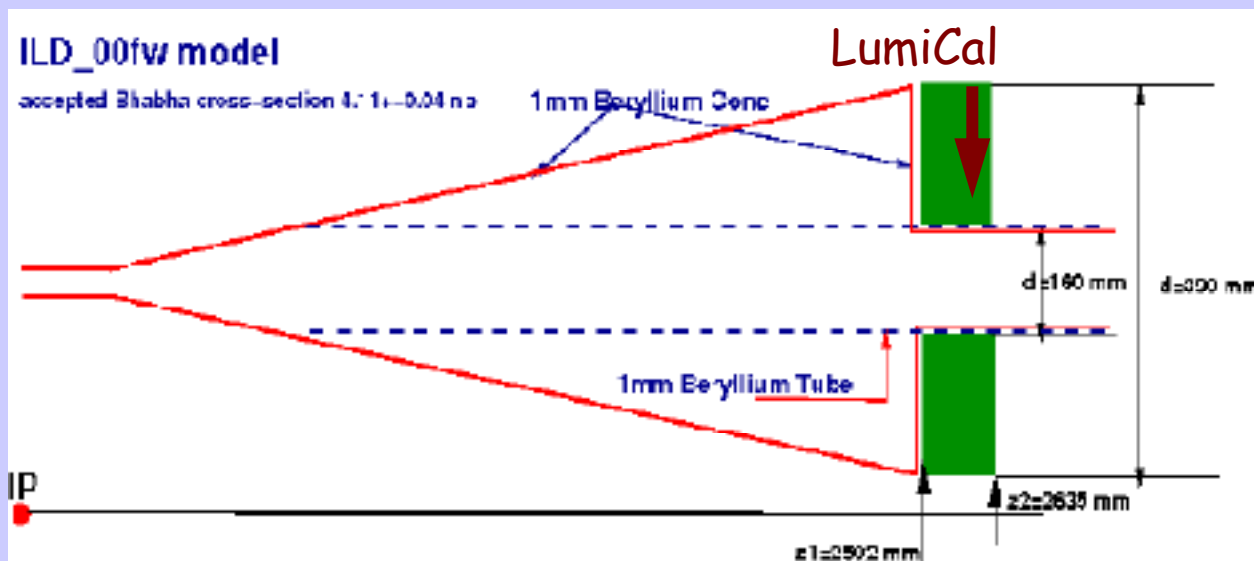


LumiCal



- Ongoing simulations to optimize detector design for
 - precise luminosity measurement,
 - hermeticity (electron detection at low polar angles),
 - assisting beam tuning (fast feedback of BeamCal data to machine)
- Challenges: radiation hardness (BeamCal), high precision (LumiCal) and fast readout (both)

Simulation Studies, example beam-pipe shape



Simulation using 10^6 Bhabha events indicates no impact on the precision of the Lumi measurement

However: keep the conical volume empty

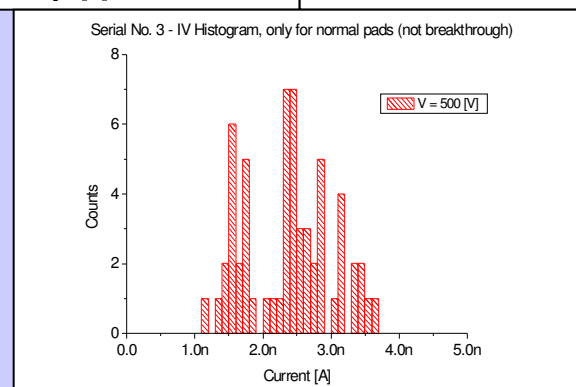
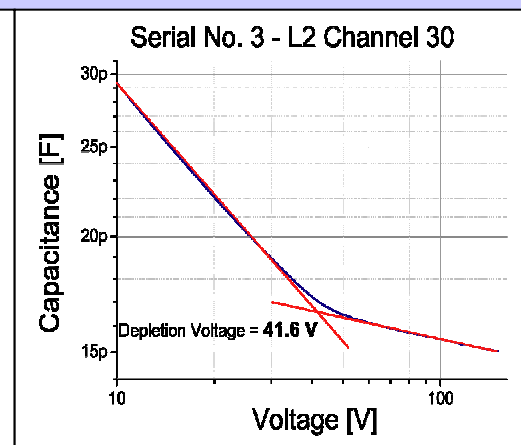
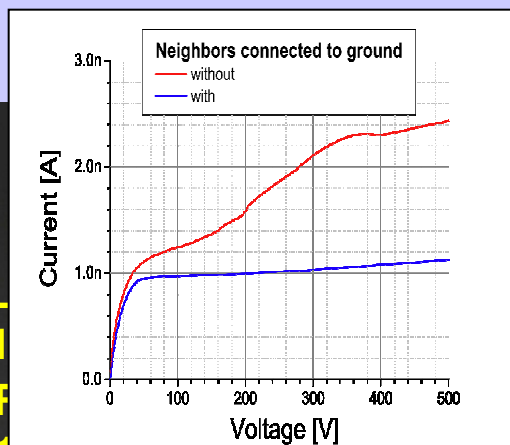
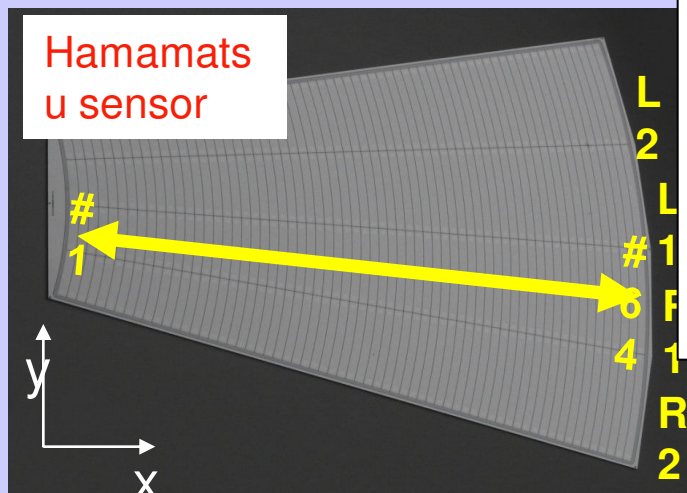
See also the talk by Ivanka Bozovic-Jelisavcic in the MDI session, Monday, March 29, 12.00, and Andre Sailer, BDS_MDI session, Monday 29 March, 2.25



LumiCal: low irradiation load → silicon-tungsten sampling calorimeter

- Design (optimized geometry for luminosity measurement)
- Hamamatsu sensor prototypes (6", p in n, DC-coupled, 350 μm thick)

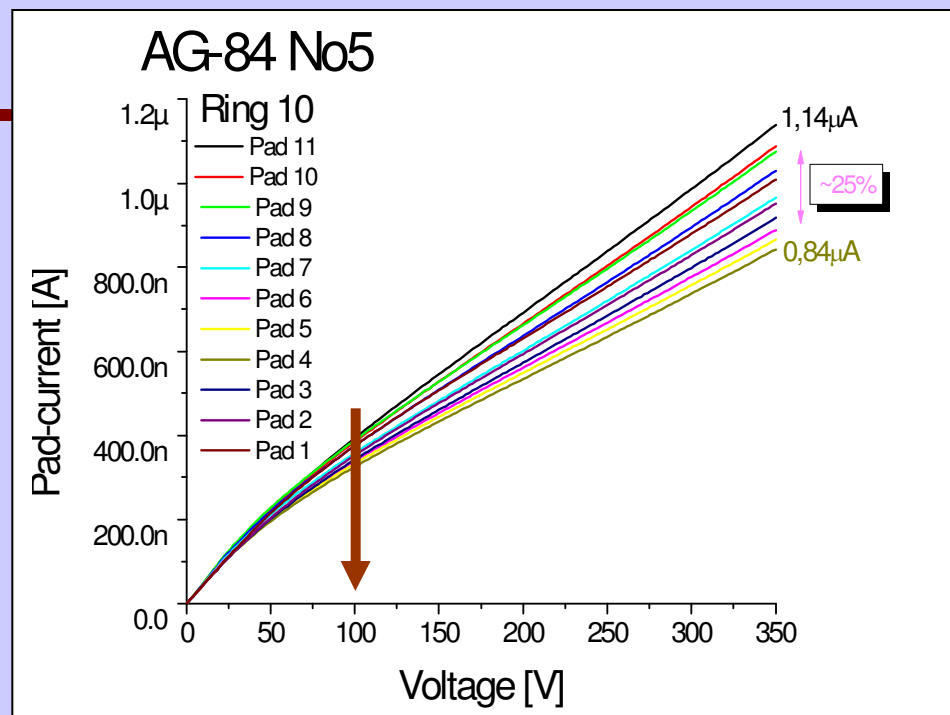
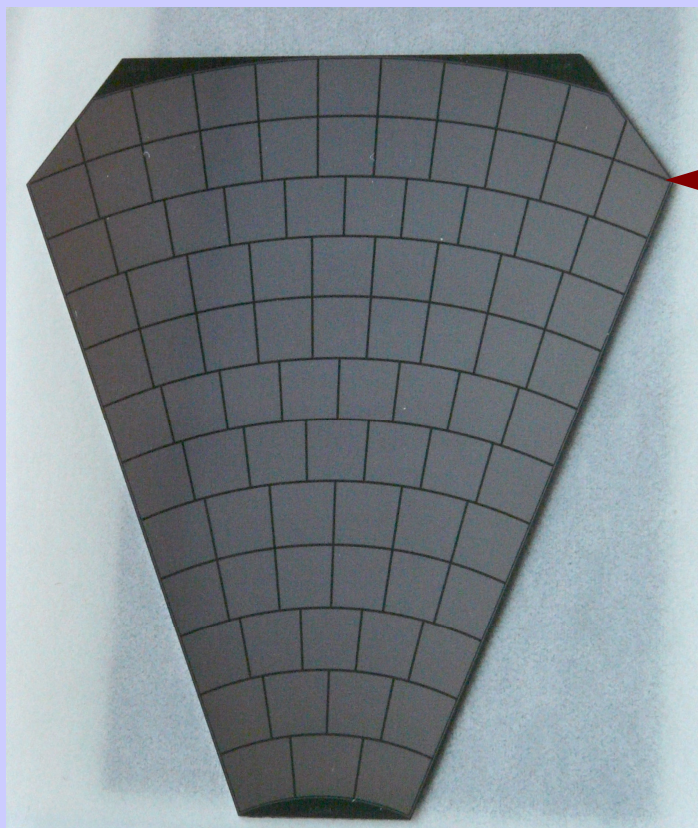
Measurements in Cracow, DESY, Tel Aviv (cross calibration)



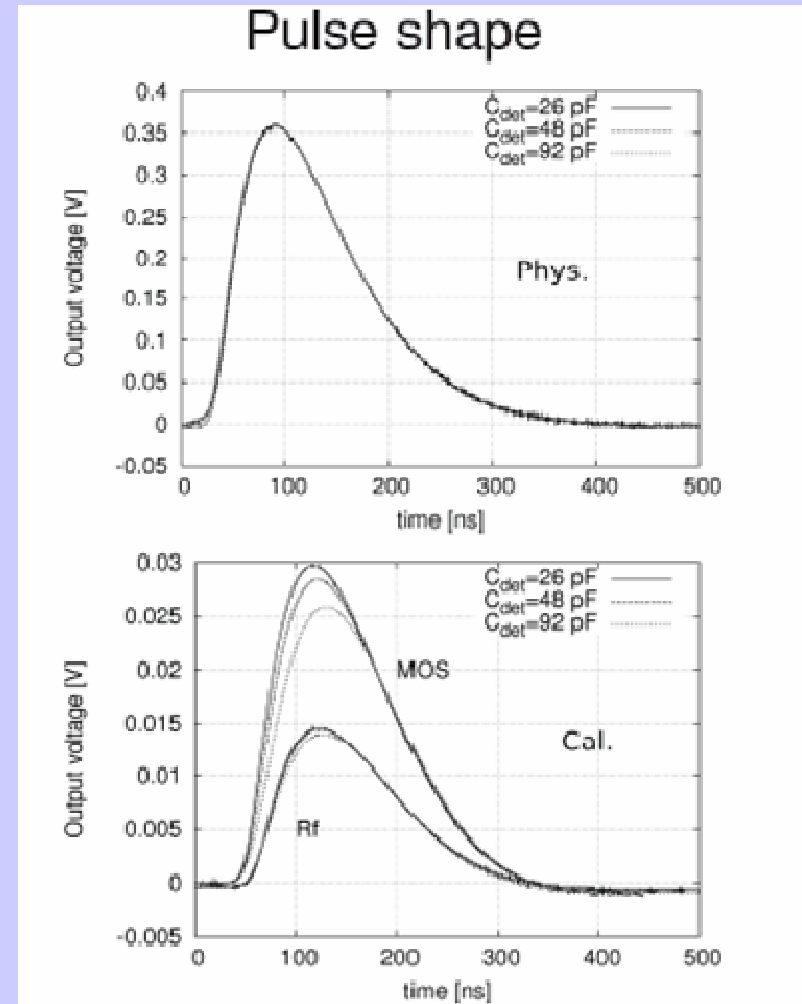
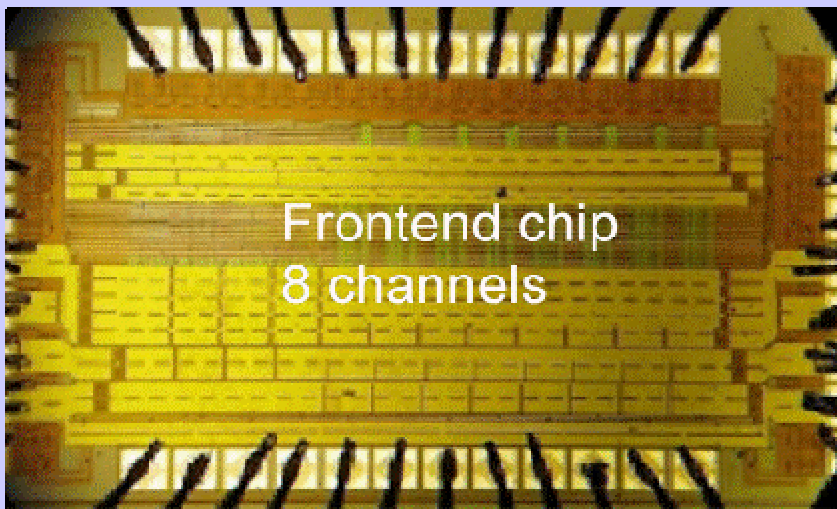
GaAs sensors, delivered by JINR
(produced in Tomsk, Siberian
Academy of Science)

500 μm thickness, 3 inch wafer, Au
metallisation

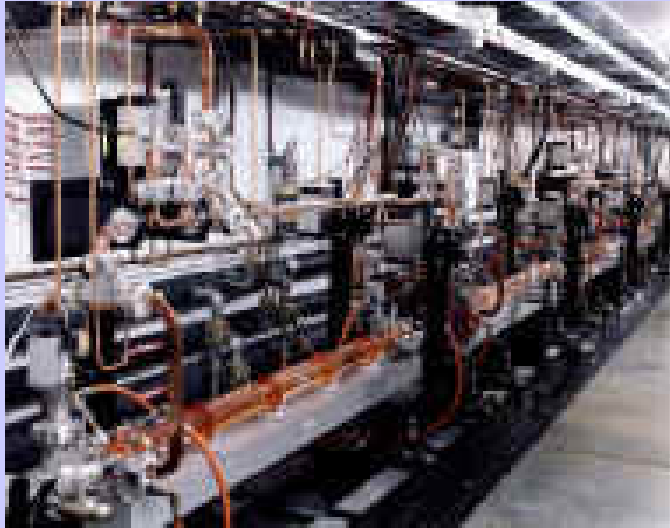
Probe station measurements



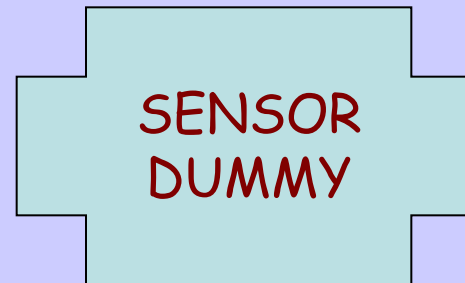
- Frontend readout prototype chip developed at UST Cracow, manufactured in a MPW run (0.35 μm AMS)
- 8 channels, passive or MOS feedback
- Two amplification ranges (MIP and physics data taking)
- Measured in Cracow and Zeuthen:
 - Noise $\approx 300 e^-$ (+ $28 e^-/\text{pF}$),
 - gain $\approx 20 \text{ mV/fC}$ (calibration mode),
0.11 mV/fC (data taking)



Rad. Hard Silicon sensor tests at the NLCTA beam (150-200 MeV electrons)



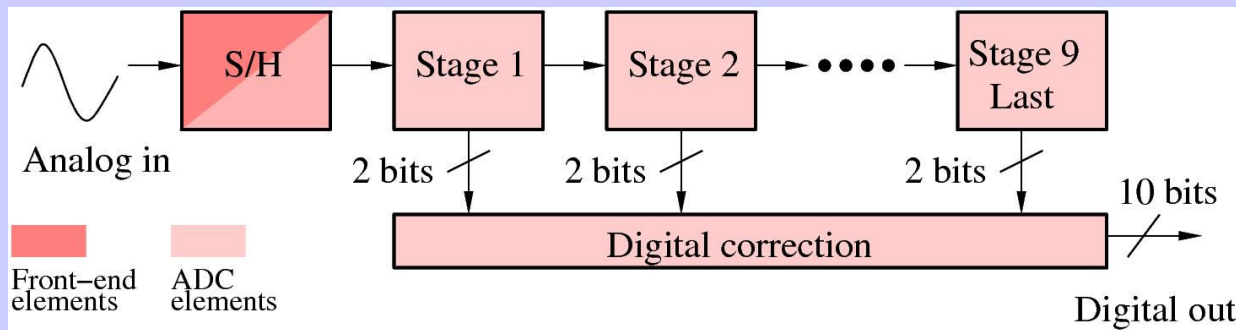
SLAC and
UC Santa Cruz



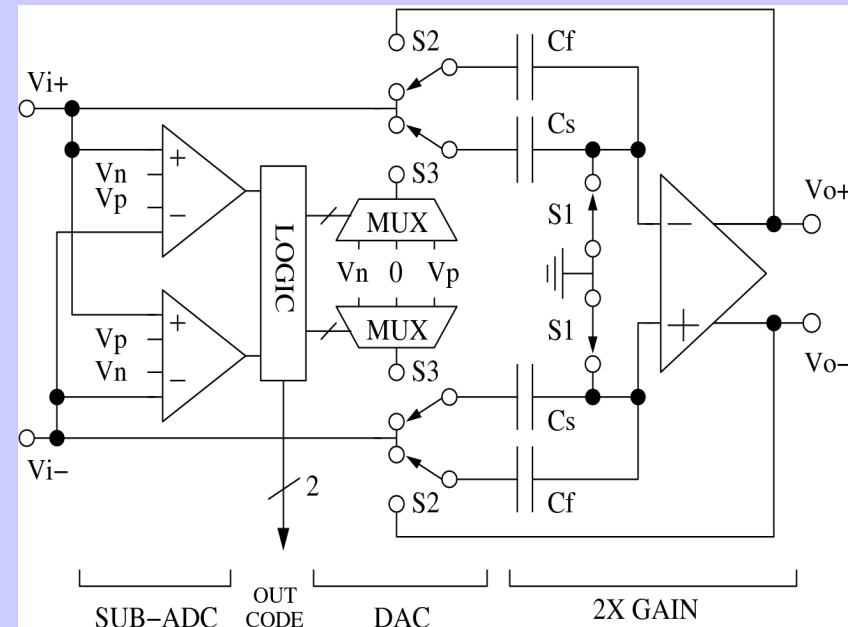
n- and p-type float-zone and magnetic Czochralski sensors

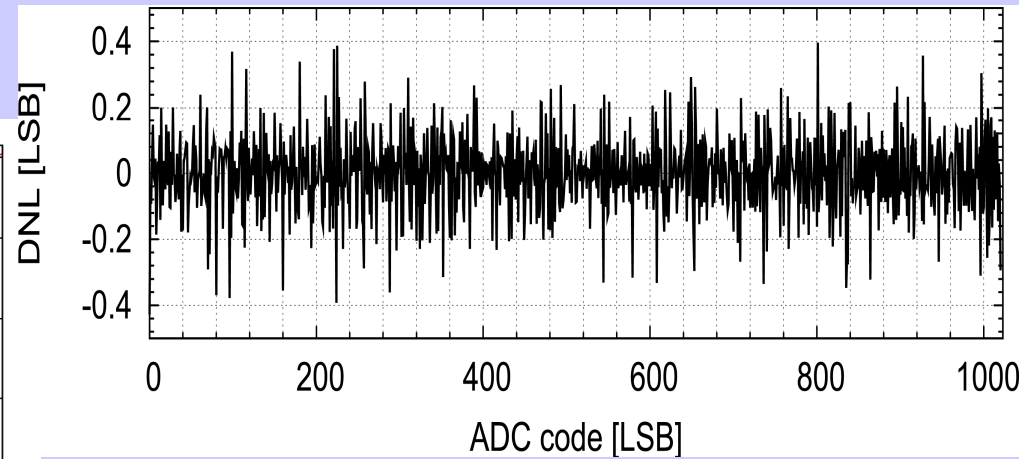
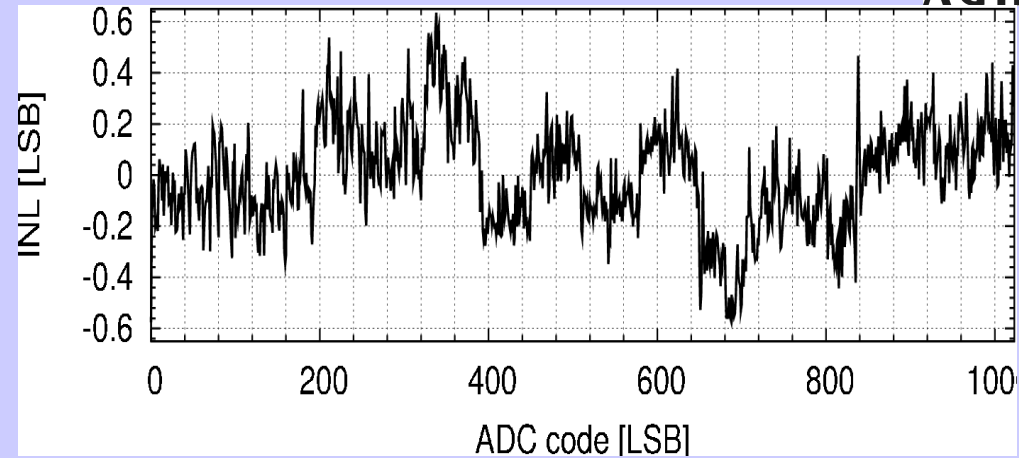
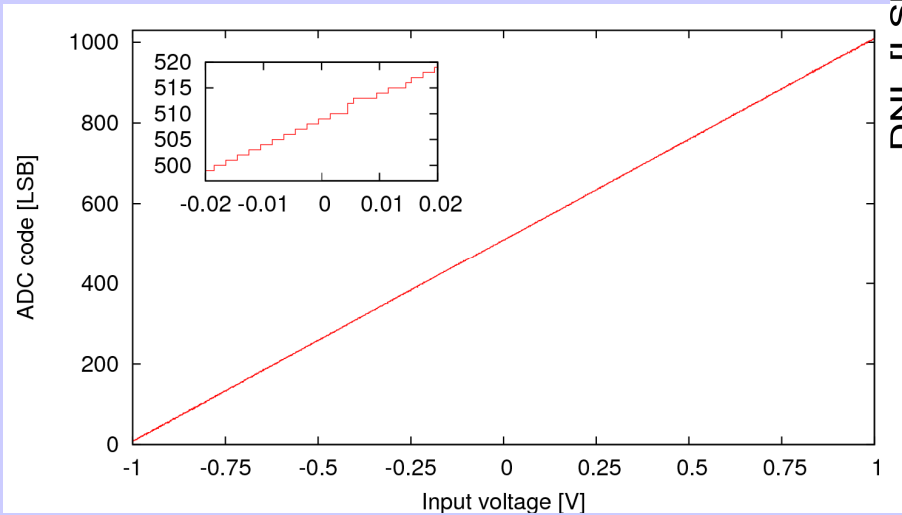
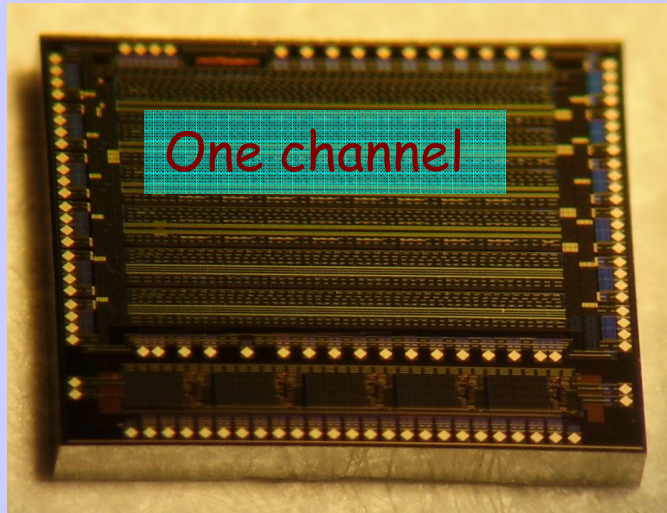
Create neutron flux by absorber

See also the talk by Bruce Schumm in the MDI session



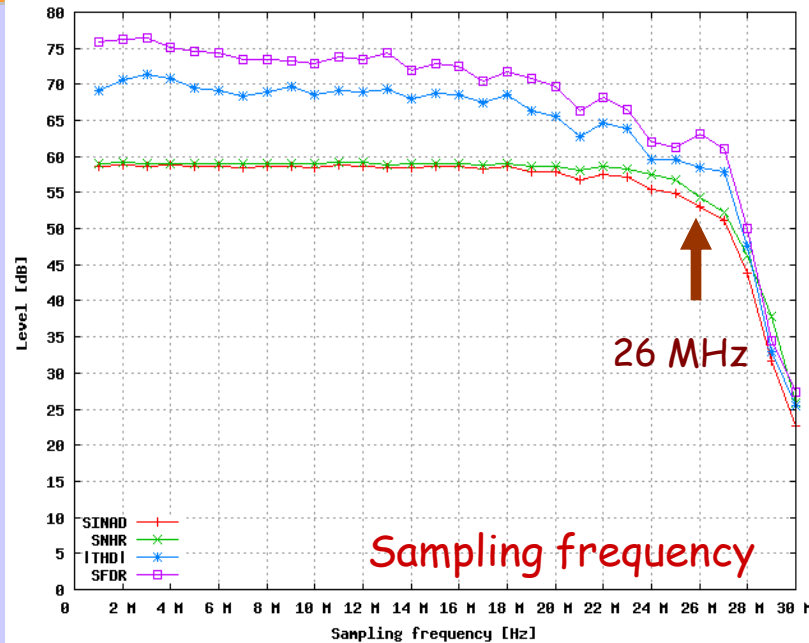
- 10 bit pipeline ADC 1.5 bit/stage
- Variable sampling frequency up to ~25 Ms/s
- Scalable power consumption
- Fully differential
- Power switching OFF/ON (ILC, CLIC beam timing)
- Present version in 0.35 μm AMS, finer pitch technology soon...





Very good linearity
 $INL < 0.61 \text{ LSB}$, $DNL < 0.5 \text{ LSB}$

S/N

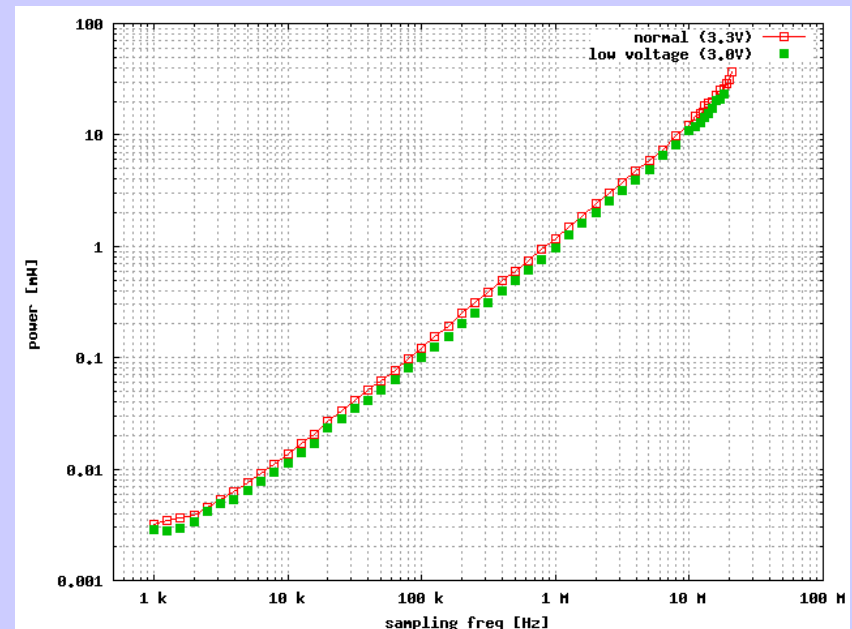


ADC dynamic measurements

Good dynamic performance ENOB
~ 9.5 bit

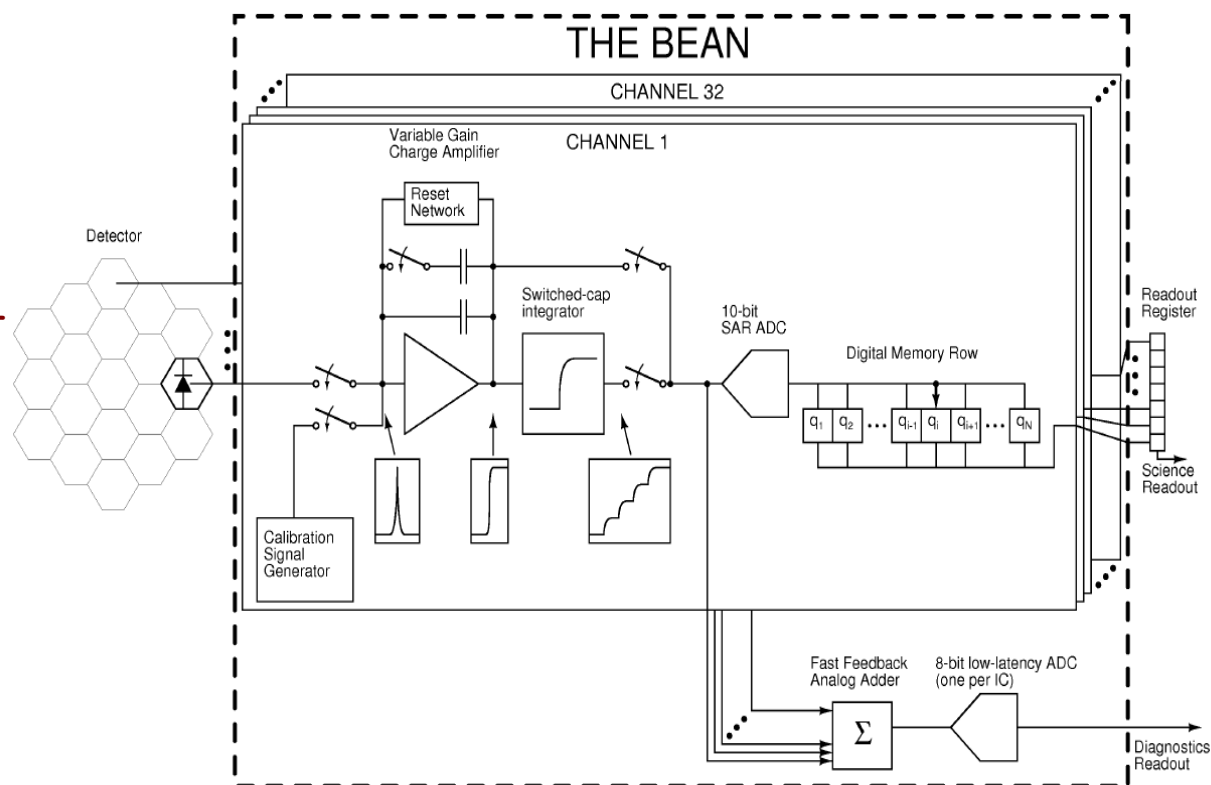
Power consumption is about 1-1.5 mW/MHz at worst case (Nyquist input frequency, including output buffers)

Power switching ON/OFF tested. Depending on sampling frequency 8-16 clocks needed to turn power ON



We have just submitted 8 channels ADC version layout with a pitch 200 μm per channel

- “High” input rate (3.25 MHz)
- High occupancy (100%)
- Large input signals ($\sim 40\text{pC}$)
- Large input capacitance ($\sim 40\text{pF}$ detector + wires)
- High resolution (10 bits)
- Dual gain (50x) for different modes of operation: science and detector calibration
- Low latency ($\sim 1\mu\text{s}$) output for beam diagnostics
- High radiation (1Mrad total dose)

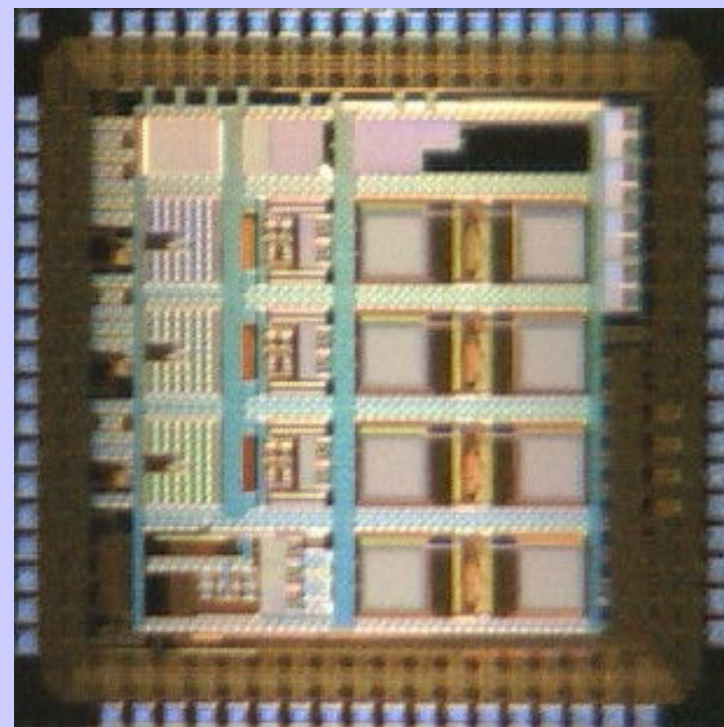
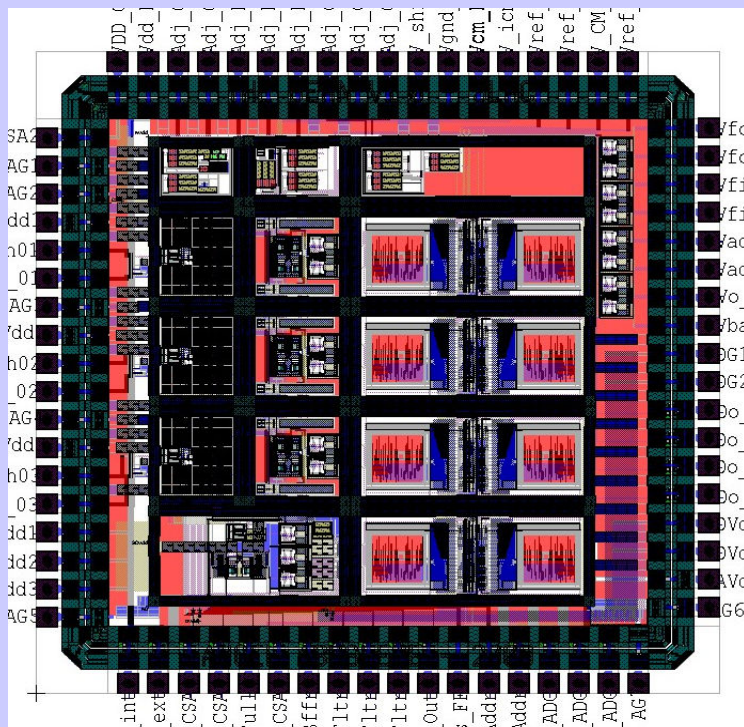


- Design at Stanford University (KPiX technology)
- readout between bunch trains
- prepared for fast feedback (diagnostics readout to machine)
- prototypes now available

See also the talk by Angel Abusleme in the MDI session

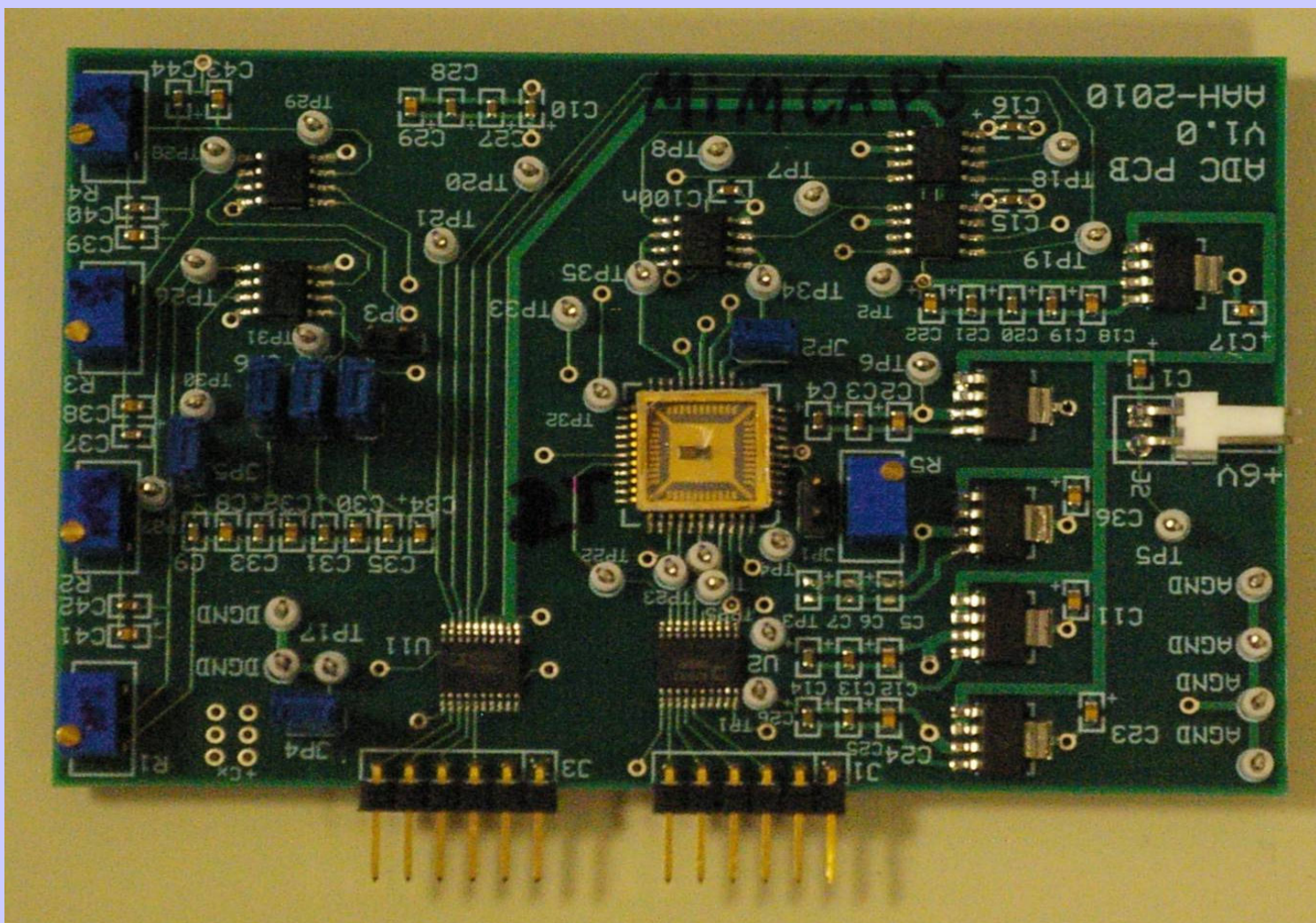
March 28, 2010

LCWS Beijing

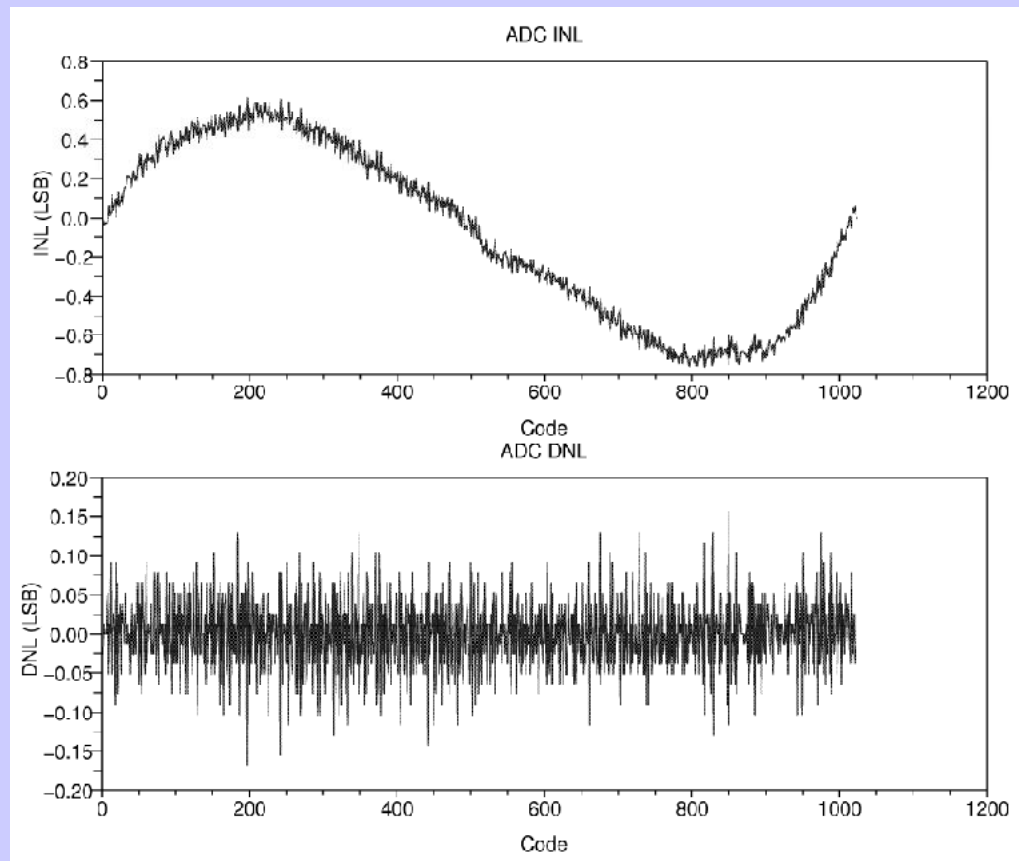


- TSMC 0.18um, 1.8V
- 72 pads, 2.4mm x 2.4mm (incl. pads)
- 7306 nodes, 35789 circuit elements
- 3 charge amplifiers, 4 x 10-bit, fully diff. SAR ADCs, 1 SC adder, 3 SC filters

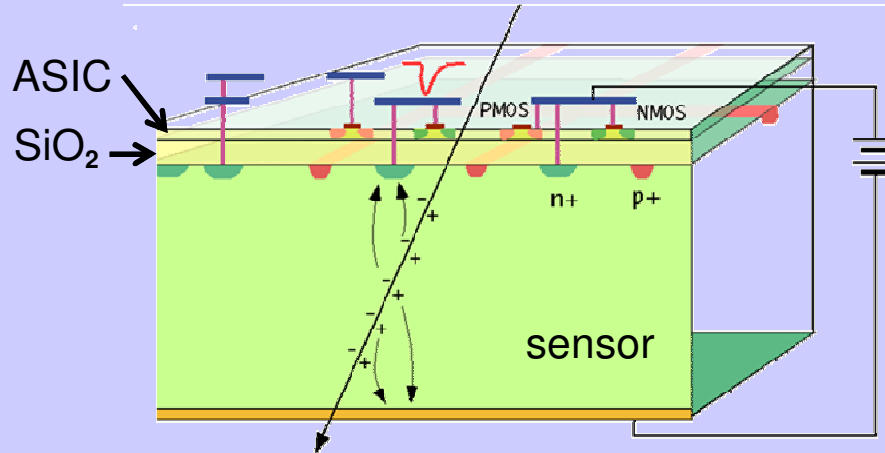
ADC Test Board



- MIMCaps (16-fF unit capacitance) ADC linearity results:
 - DNL is excellent, no missing codes
 - INL looks strange, but cause has been explained (copper dishing)
 - ADC meets noise and speed requirements



Pair Monitor



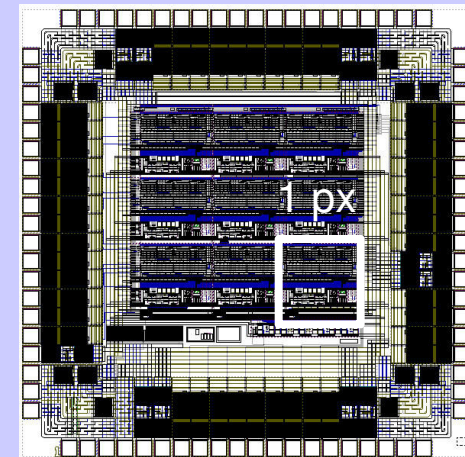
- Pixel size: $400 \times 400 \mu\text{m}^2$
- Radius: 10 cm
- Total number of pixels: **~200,000**



→ Monolithic construction allows the elimination of the bump-bonding process.

- First step: design of a readout prototype ASIC for 3×3 pixels:
- digital readout (preamp, discriminator, counter)

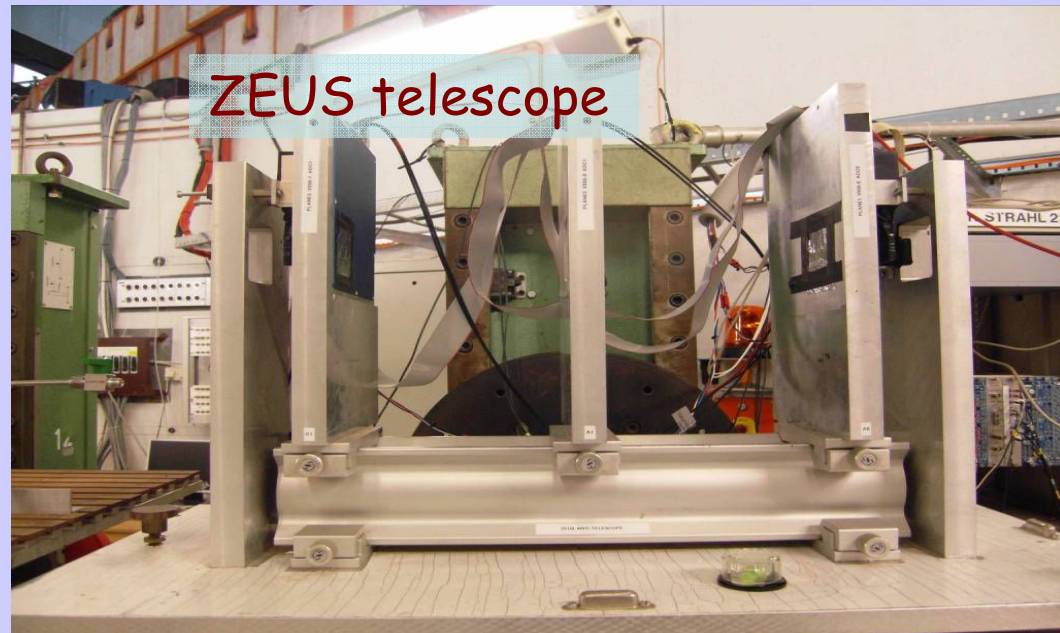
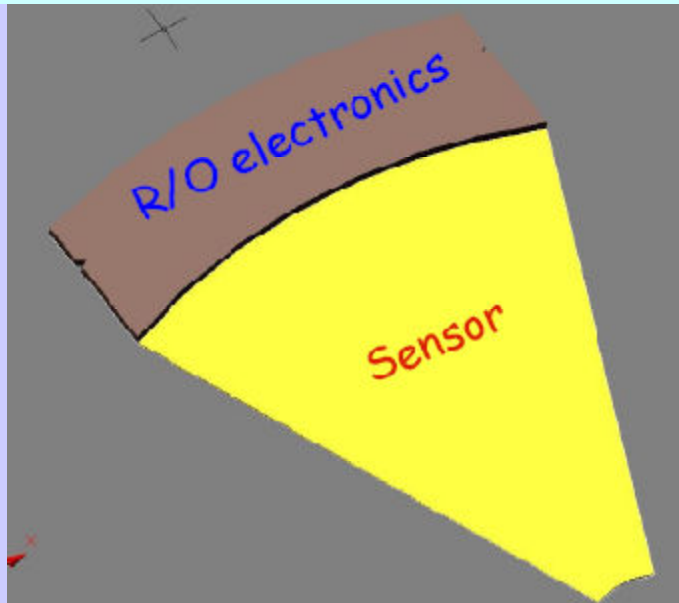
- manufactured chip (CMOS $0.2 \mu\text{m}$, SOI technology)
- performance measurements:
 - gain: $\sim 17 \text{ mV/fC}$
 - noise: $\sim 260 e^-$ (+ $130 e^-/\text{pF}$) @ signals $\sim 20000 e^-$



Shortterm (2012):

Full assembly of a Prototype Sector

- Sensors and ASICs connection (Cracow, DESY, help from other labs)
- DAQ (+Tel Aviv)
- Preparation of a Beamtest in Summer at DESY



- intense simulation effort to understand signal and background in LumiCal and BeamCal at 3 TeV for the CLIC detector CDR April 2011

Midterm (>2012):

FP7 application (AIDA)

- Infrastructure to allow 'Physics studies' after 2012
- Cracow (2x), DESY, Tel Aviv (from EUDET)
+ VINCA and IFIN-HH (associats)

FP7 Partners:

AGH-UST Cracow (Marek Idzik)
CERN Geneva (Lucie Linssen)
DESY Zeuthen (W. Lohmann)
IFJPAN Cracow (L. Zawiejski)
TAU Tel Aviv (H. Abramowicz)

FCAL Specific infrastructure:

- Flexible, high precision tungsten structure
- Fast FE Readout
- Module construction and test devices (jigs, mechanics and electronics test facilities)
- Position control devices

